| | Type | Hits | Search Text | DBs | Time Stamp | Comments | Error Definition |
|---|---|---|---|---|---|---|---|
| 1 | BRS | 195 | adhesive with outgassing | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:44 | | |
| 2 | BRS | 3 | ((solder adj mask) with out$1gass$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:51 | | |
| 3 | BRS | 165 | solder same out$1gass$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:22 | | |
| 4 | BRS | 10 | ((solder adj mask) same out$1gass$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:52 | | |
| 5 | BRS | 73 | (solder same out$1gass$3) and adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:21 | | |
| 6 | BRS | 24 | (solder with out$1gass$3) and adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:22 | | |
| 7 | BRS | 850 | (solder adj mask) and (adhesive or bismaleimide) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:19 | | |
| 8 | BRS | 285 | (solder adj mask) same (adhesive or bismaleimide) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:24 | | |
| 9 | BRS | 162 | ((solder adj mask) same (adhesive or bismaleimide) ) and (die or chip) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:21 | | |
| 10 | BRS | 6 | (solder adj mask) same bismaleimide | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:41 | | |
| 11 | BRS | 4 | (solder adj mask) and ((bismaleimide or bt) with adhesive) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:44 | | |
| 12 | IS&R | 1 | ("6034194").PN. | USPAT | 2001/11/29 13:45 | | |
| 13 | BRS | 4 | (solder adj mask) and ((bismaleimide or bt or bmi) with adhesive) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:59 | | |
| 14 | BRS | 112 | (chip or die) and ((bismaleimide or bt or bmi) with adhesive) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 13:59 | | |
| 15 | BRS | 17 | ((chip or die) and ((bismaleimide or bt or bmi) with adhesive) ) and mask | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 14:07 | | |
| 16 | IS&R | 1 | ("6034194").PN. | USPAT | 2001/11/29 14:13 | | |
| 17 | BRS | 7 | ((solder adj mask) with outgas$) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 14:18 | | |
| 18 | BRS | 15829 | cure with adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/29 15:54 | | |

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|---|------|------|-------------|-----|------------|----------|------------------|
| 1 | BRS | 195 | adhesive with outgassing | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:44 | | |
| 2 | BRS | 3 | ((solder adj mask) with out$1gass$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:51 | | |
| 3 | BRS | 165 | solder same out$1gass$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:22 | | |
| 4 | BRS | 10 | ((solder adj mask) same out$1gass$3) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 18:52 | | |
| 5 | BRS | 73 | (solder same out$1gass$3) and adhesive | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2001/11/28 19:21 | | |
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11/29/2001, EAST Version: 1.02.0008